LATEST NEWS





The ESCC QPL March was published with 4 extensions, 1 amendment and 2 Revisions

For more information, please click HERE



EPPL (European Preferred Parts List) issue 35

The ESCC EPPL issue 35 was published February 2018.

ESCC QML January 2018

The ESCC QML issue 16 was published in January 2018 to include: Addition of Process Capability Approval of 3D PLUS (France)

IST Newly Qualified Manufacturer



IST AG - Innovative Sensor Technolgy is now qualified with thier Thermistors: Resistance Temperature Detector, Thin film Platinum Sensor, PTC, range 100 to 2000 Ohms at O°C.

NEW ESCC Process Capability Approval



3D Plus is now certified in accordance with ESCC 2566001 for its 3D Staking Technology Modules!!

NEW ESCC Specification Published:4006/015



February 2018: A NEW ESCC Detail Specification:4006/015 RESISTANCE TEMPERATURE DETECTOR THIN FILM PLATINUM SENSOR, PTC RANGE 100 TO 2000

OHMS AT 0°C, WITH A TEMPERATURE RANGE OF -200°C TO +200°C **Issue 1**. Please click <u>HERE</u> for more information.

NEW ESCC Specification Published:3702/002

February 2018: A NEW ESCC Detail Specification:3702/002 SWITCHES, THERMOSTATIC, BIMETALLIC, SPST WITH SNAP ACTION, OPENING OR CLOSING CONTACT, POTTED AND LEADED BASED ON TYPE TH473

Issue 1. Please click **HERE** for more information.



NEW ESCC Specification Published:2543201

March 2018: REQUIREMENTS FOR TECHNOLOGY FLOW QUALIFICATION OF COILS, RF AND POWER, FIXED (INDUCTORS AND TRANSFORMERS)

Issue 1. Please click HERE for more information.

ECSS-Q-ST-70-38rev1 (15 September 2017) Published

This Standard prescribes requirements for electrical connections of leadless and leaded surface mounted devices (SMD) on spacecraft and associated equipment, utilising a range of substrate assemblies and employing solder as the interconnection media. Please click HERE to view the document

UPCOMING EVENTS



NSREC 2018

NSREC 2018 will take place in Kona, Hawaii from 16 - 20 of July 2018. For more information, please click <u>HERE</u>



Radecs 2018

Radecs with take place in Gothenburg, Sweden from 16th to 21rst of September 2018. For more information, please click <u>HERE</u>

RECENTLY PUBLISHED ESCC SPECIFICATION

NEW ESCC Specifications published since 15th February 2018

Number	Title
4006/015	RESISTANCE TEMPERATURE DETECTOR THIN FILM PLATINUM SENSOR, PTC RANGE 100 TO 2000 OHMS AT 0°C, WITH A TEMPERATURE RANGE OF - 200°C TO +200°C

3702/002	SWITCHES, THERMOSTATIC, BIMETALLIC, SPST WITH SNAP ACTION, OPENING OR CLOSING CONTACT, POTTED AND LEADED BASED ON TYPE TH473
2543201	REQUIREMENTS FOR TECHNOLOGY FLOW QUALIFICATION OF COILS, RF AND POWER, FIXED (INDUCTORS AND TRANSFORMERS)

Up-Issued ESCC Specifications published since 15th February 2018

Number	Title
00000	CHARTER OF THE EUROPEAN SPACE COMPONENTS COORDINATION
<u>11302</u>	ORGANISATION OF THE EUROPEAN SPACE COMPONENTS CONFERENCE
2054009	EXTERNAL VISUAL INSPECTION OF FLEXIBLE HEATERS
2264000	EVALUATION TEST PROGRAMME FOR RESISTORS
2269010	EVALUATION TEST PROGRAMME FOR MONOLITHIC MICROWAVE INTEGRATED CIRCUITS (MMICs)
9408/052	INTEGRATED CIRCUITS, SILICON MONOLITHIC, HMOS QUAD BILATERAL SWITCH BASED ON TYPE 54HC4066
<u>3702</u>	SWITCHES, THERMOSTATIC, BIMETALLIC, HERMETICALLY SEALED
9000	INTEGRATED CIRCUITS: MONOLITHIC AND MULTICHIP MICROCIRCUITS, WIRE-BONDED, HERMETICALLY SEALED AND FLIP-CHIP MONOLITHIC MICROCIRCUITS, SOLDER BALL BONDED, HERMETICALLY AND NON-HERMETICALLY SEALED AND DIE
3601/001	RELAY, ELECTROMAGNETIC, NON-LATCHING, 28VDC, 10A, 2PDT
3602/001	RELAY, ELECTROMAGNETIC, LATCHING, 28VDC, 10A, 2PDT
3702/001	SWITCHES, THERMOSTATIC, BIMETALLIC, SPST WITH SNAP ACTION, WITH PENING OR CLOSING CONTACT BASED ON TYPE TH47